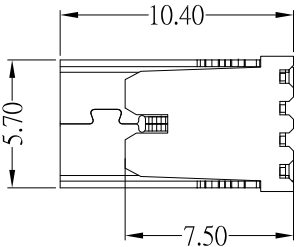
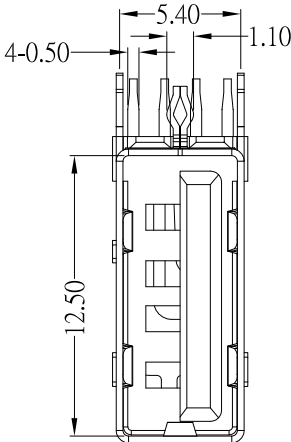
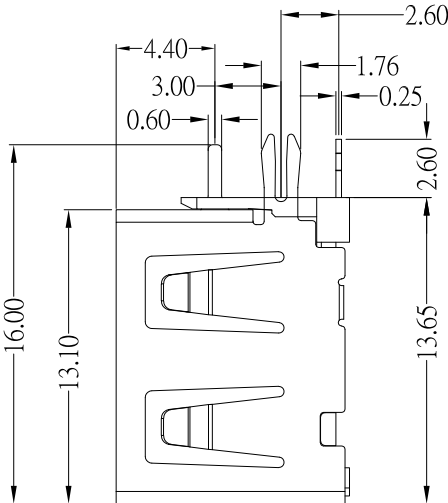
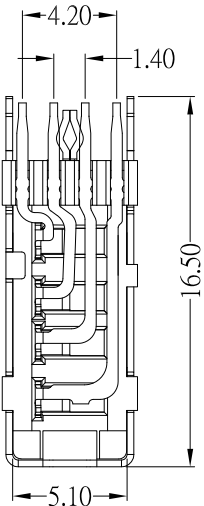
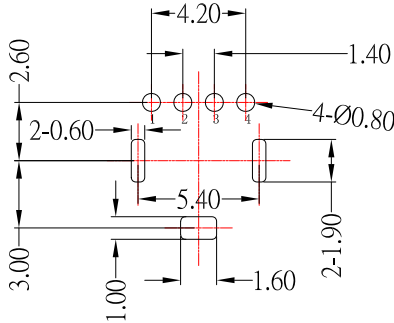
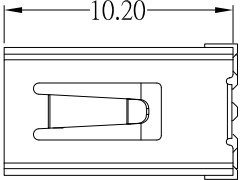


SUA-110P13Bx-xx-S236

SHELL :
Blank : BRASS
I : SPCC

鍍層厚度 :
Blank : 1u"
2 : 15u"
3 : 30u"

Color :
Black : B
White : W



PCB LAYOUT MOUNTING PATTERN

SPECIFICATIONS

Electrical:

- 1.Rated Current: 2.0 A Max
- 2.Dielectric Withstanding Voltage: AC 500 V / 1MIN
- 3.Insulation Resistance: 1,000 MΩ Min
- 4.Contact Resistance: 30 mΩ Max

Material:

- 1.Housing: PBT
- 2.Contact: PhosphorBronze
- 3.Shell: Brass / Spcc

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED :
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3

3RD.
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao
DATE: 06/10/26
DATE: 06/10/26
DATE: 06/10/26

MAT'L	TITLE	CONNECTOR
FINISH	MODLE	USB AF 側插短體外殼魚叉腳無捲邊 L=10.40mm
SCALE	1 : 1	DWG NO. SUA-110P13Bx-xx-S236
SHEET NO.	1 of 1	PART NO. SUA-110P13Bx-xx-S236
		SIZE A4
		VER R2

ITEM NO.	DESCRIPTION	DRAWN	DATE
2	新增顏色選項	Jack	061026
1	新增尺寸	Jack	042622